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NOTES:												
1.MATERIAL: HOUSING: HIGH TEMPERATURE NYLO												
TERMINAL: COPPER ALLOY.	N, GERSS HELED GESTV	o INIED.		C	ONNEC	TOR #	# POS REF.	N	DIM "A"	DIM "B"	DIM "C"	"E"
PLATING: 50u" NICKEL UNDERPLATE CONTACT AREA PLATING -	ALL OVER	CODE			1 005		70		7.05	05.00	0.15	6.00
SOLDER TAIL: TIN OR TIN	/LEAD(90/10)- SEE PF	RODUCT			1 POF	۲I	36	6	7.65	25.00	9.15	6.00
NUMBER CO METAL BOARD LOCKS: COPPER ALL	DDE 100u" MIN. OVER 50	u" NICKEL.			4 POF	रा	64	20	21.65	39.00	23.15	20.00
FINISH: 100u" TIN OR TIN/LEAD(90	0/10) OVER 50u" NICKEL				8 POF	रा	98	37	38.65	56.00	40.15	37.00
UNDERPLATE SEE PRODUCT 2.PRODUCT SPECIFICATION: GS-12-2					16 POF	RT	164	70	71.65	89.00	73.15	70.00
3THE HORIZONTAL AXIS FOR THE HO		SHED BY			10 1 01		104	/0	/1.00	03.00	/3.13	70.00
A LINE THROUGH THE CENTER OF THE VERTICAL AXIS IS 90° TO THE		UGH THE CENTER										
OF DATUM Z.												
(4)NO TIE BAR PERMITTED FROM CARE (5)CHAMFER EDGES MUST BE FREE O		E OF PAD FOR PINS A1 AND F	'IN NUM	IBERS "F	•							
© FREQUENCY & LOCATION AT SUPPL	LIER DISCRETION. RIDGE	MAY BE CONTINUOUS WITH NO I	BREAKS									
7.RoHS COMPATIBLE PRODUCT SPECIF a — PLATING:	FICATIONS:											
- "LF" MEANS THE PRODUCT		IMUM MATTE TIN OVER 1.27um										
MINIMUM NICKEL UNDERPLA b - MANUFACTURING PROCESS C												
– THE HOUSING WILL WITHSTAT		±5°C TEMPERATURE FOR										
10 SECONDS IN RE-FLOW	APPLICATION, REFER TO	GS-14-858 FOR OPERATING.										
PRODUCT NU												
10018783 -¥ ¥ ¥ ¥	;¥¥₽ <u>₽₽</u>	LEAD FREE OPTION										
HOUSING COLOR OPTIONS		K FOR TERMINAL PLATING 3.4.5										
0-NATURAL 1-BLACK		RMINAL PLATING OPTION 0,1,2		KAGING		·						
PEGS OPTIONS					Y PACKA		IYLAR TAPE. SE	E FIGULE	1			
0-PLASTIC PEGS							R 164P ONLY) H MYLAR (FOR	1010 01	u x2			
1-METAL BOARD LOCKS 2-SINGLE PLASTIC PEGS		POS OPTIONS	2-6		T PACKA	AGING WITH	MILAR (FOR	104P UN	LT)			
		0-36 1-64				NGTH OPTI	IONS					
TERMINAL PLATING OPTIONS	l	2-98	1									
0-50u" Ni UNDERPLATE 30u" Au CONTACT AREA		3-164				PCB THICK	KNESS BOARD	LOCKS E	IM "G"			
100u" TIN TAIL AREA COMPATI 1-50u" Ni UNDERPLATE	IBLE RoHS			0 2.30	+0.25 -0.13	1.56±0.1	0 1.70	±0.15				
15u" Au CONTACT AREA				1 3.10	+0.25 -0.13	2.36±0.1	0 2.50	±0.15				
100u" TIN TAIL AREA COMPATI 2-50u" Ni UNDERPLATE	IBLE ROHS			2 2.54	±0.25	1.56±0.1	0 170	±0.15				
GOLD FLASH CONTACT AREA 100u" TIN TAIL AREA COMPATI	IBLE ROHS					1.56±0.1		±0.15				
3–50u" Ni UNDERPLATE					±0.25	1.50±0.1						
30u" Au CONTACT AREA	VCOMPLIANT RoHS		ma	t'l. code			tolerances u otherwise sp		CUSTOME	R F		
			ltr	ecn no	dr	date	.X		COPY	1	9	www.fciconn
100u" TIN/LEAD TAIL AREA IN 4-50u" Ni UNDERPLATE	COMPLIANT POUS		U			lir	near .XX		projection	title	PCI EXPR	ESS
100u" TIN/LEAD TAIL AREA IN 4-50u" Ni UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN	COMPLIANT RONS						.XXX ngles 0*	± ±2'	╡╋⋞	31	CARD ED	
100u" TIN/LEAD TAIL AREA IN 4-50u" NI UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN 5-50u" NI UNDERPLATE	COMPLIANT NOTS						r MAGGIE WU		² MM	product fan	nily EDGE	CARD
100u" TIN/LEAD TAIL AREA IN 4-50u" Ni UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN							ngrRYLIU	07/30/0	2	- size dwg		
100u" TIN/LEAD TAIL AREA IN 4-50u" NI UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN 5-50u" NI UNDERPLATE GOLD FLASH CONTACT AREA										-		-
100u" TIN/LEAD TAIL AREA IN 4-50u" NI UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN 5-50u" NI UNDERPLATE GOLD FLASH CONTACT AREA						cł	hr R Y LIU	07/30/0	2 scale	A4	100187	83
100u" TIN/LEAD TAIL AREA IN 4-50u" Ni UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN 5-50u" Ni UNDERPLATE GOLD FLASH CONTACT AREA			she	et rev	ision	cł		07/30/0	2 scale	A4	100187	83
100u" TIN/LEAD TAIL AREA IN 4-50u" NI UNDERPLATE 15u" Au CONTACT AREA 100u" TIN/LEAD TAIL AREA IN 5-50u" NI UNDERPLATE GOLD FLASH CONTACT AREA			she			cł	hr R Y LIU	07/30/0	2 scale		100187	

